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**CONFIRMATION NO. 3533** 

SERIAL NUMBER 10/044,964	FILING DATE 01/15/2002 RULE		700		UP ART U -2121- -2125	TINL	ATTORNEY DOCKET NO. 088941-0203
APPLICANTS Sumio Ogawa, Higashihiroshima-shi, JAPAN; Minoru Ueki, Higashihiroshima-shi, JAPAN; Shinichi Hara, Shimonoseki-shi, JAPAN;  "** CONTINUING DATA **********************************							
Foreign Priority claimed  35 USC 119 (a-d) conditions met  Verified and Acknowledged  Lyes no Met after  yes no Met after  initials			STATE OR COUNTRY JAPAN	DRAWING CLA		TOTAL CLAIM	
ADDRESS 22428							
TITLE  Method of manufacturing semiconductor devices							
RECEIVED No.	:: Authority has been given in Paper to charge/credit DEPOSIT ACCOUNT for following:				All Fees  1.16 Fees ( Filing )  1.17 Fees ( Processing Ext. of time )  1.18 Fees ( Issue )  Other  Credit		